

# XP06112 (XP6112)

Silicon PNP epitaxial planer transistor

For switching/digital circuits

## ■ Features

- Two elements incorporated into one package.  
(Transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half.

## ■ Basic Part Number of Element

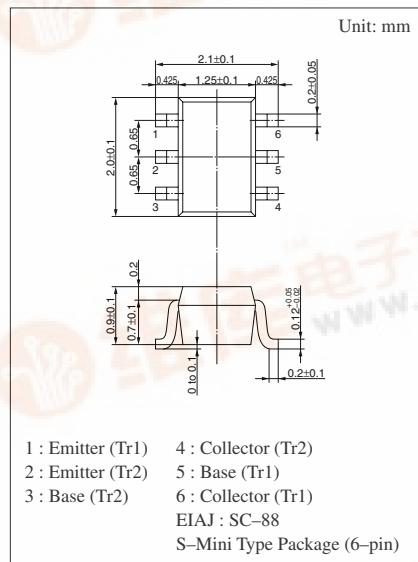
- UNR1112(UN1112) × 2 elements

## ■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Rating of element	V <sub>CBO</sub>	-50	V
	V <sub>CEO</sub>	-50	V
	I <sub>C</sub>	-100	mA
Overall	P <sub>T</sub>	150	mW
	T <sub>j</sub>	150	°C
	T <sub>stg</sub>	-55 to +150	°C

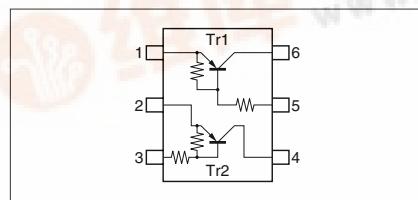
## ■ Electrical Characteristics (Ta=25°C)

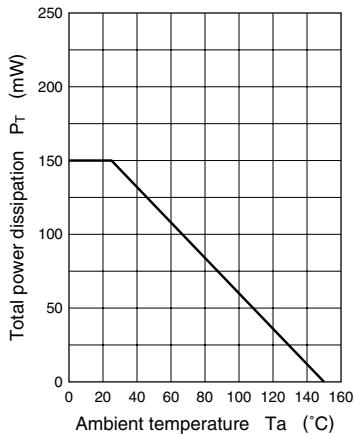
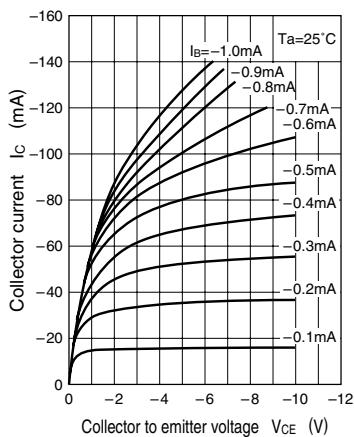
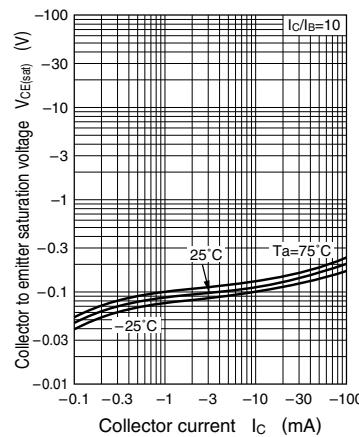
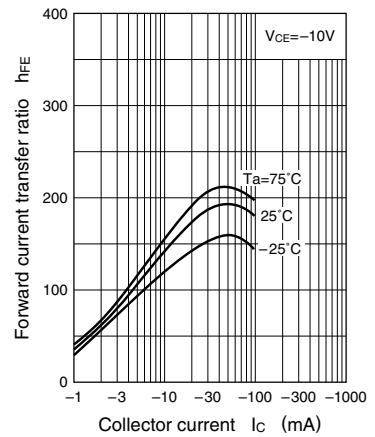
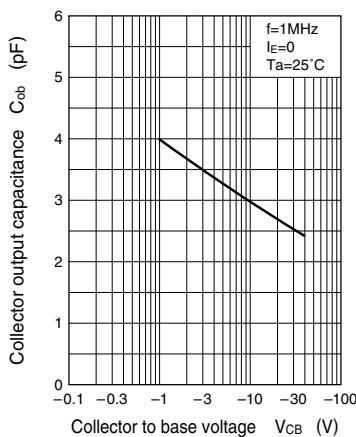
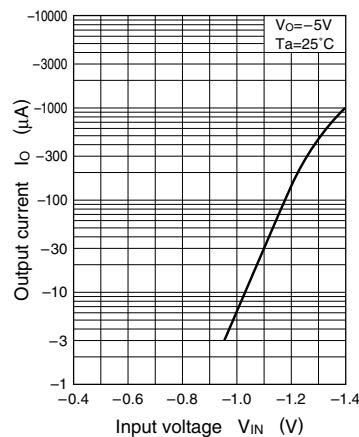
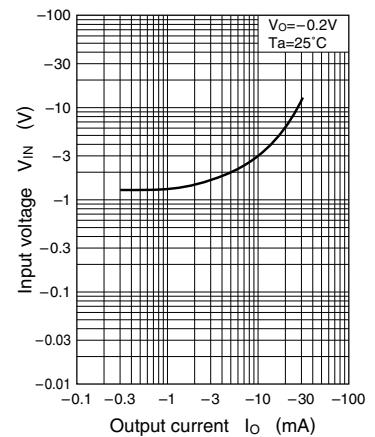
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	I <sub>C</sub> = -10μA, I <sub>E</sub> = 0	-50			V
Collector to emitter voltage	V <sub>CEO</sub>	I <sub>C</sub> = -2mA, I <sub>B</sub> = 0	-50			V
Collector cutoff current	I <sub>CBO</sub>	V <sub>CB</sub> = -50V, I <sub>E</sub> = 0			- 0.1	μA
	I <sub>CEO</sub>	V <sub>CE</sub> = -50V, I <sub>B</sub> = 0			- 0.5	μA
Emitter cutoff current	I <sub>EBO</sub>	V <sub>EB</sub> = -6V, I <sub>C</sub> = 0			- 0.2	mA
Forward current transfer ratio	h <sub>FE</sub>	V <sub>CE</sub> = -10V, I <sub>C</sub> = -5mA	60			
Forward current transfer h <sub>FE</sub> ratio	h <sub>FE</sub> (small/large) <sup>①</sup>	V <sub>CE</sub> = -10V, I <sub>C</sub> = -5mA	0.5	0.99		
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -10mA, I <sub>B</sub> = - 0.3mA			- 0.25	V
Output voltage high level	V <sub>OH</sub>	V <sub>CC</sub> = -5V, V <sub>B</sub> = - 0.5V, R <sub>L</sub> = 1kΩ	-4.9			V
Output voltage low level	V <sub>OL</sub>	V <sub>CC</sub> = -5V, V <sub>B</sub> = -2.5V, R <sub>L</sub> = 1kΩ			- 0.2	V
Transition frequency	f <sub>T</sub>	V <sub>CB</sub> = -10V, I <sub>E</sub> = 1mA, f = 200MHz		80		MHz
Input resistance	R <sub>I</sub>		-30%	22	+30%	kΩ
Resistance ratio	R <sub>1</sub> /R <sub>2</sub>		0.8	1.0	1.2	



Marking Symbol: 6V

## Internal Connection



$P_T$  — Ta $I_C$  —  $V_{CE}$  $V_{CE(\text{sat})}$  —  $I_C$  $h_{FE}$  —  $I_C$  $C_{ob}$  —  $V_{CB}$  $I_O$  —  $V_{IN}$  $V_{IN}$  —  $I_O$ 

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